

Article

## Comparison of properties of Al-Cu soldered and resistance welded joints

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**Abstract:** The paper presents the results of qualitative tests of Cu-Al joints made by soldering, brazing and resistance welding. Aluminum and copper tubes with a diameter of 6.9 mm, used, among others in refrigeration systems, were soldered with ZnAl2 and AlSi12 filler metal. In addition, similar connections were made by resistance welding. Macroscopic tests of soldered and welded joints were carried out and the hardness distribution on the cross-section of joints was determined. The analysis of research results allowed to state that resistance welding of Cu-Al joints can be a good alternative to the soldering process, especially in series production, due to the possibility of easy application of process mechanization.

**Keywords:** soldering; brazing; resistance welding; Cu-Al joints

### Introduction

The possibility of joining aluminum with copper by welding [1], braze welding using the TIG method [2] and optimization of the soldering process [3-5] has been devoted to many research works due to the increasing use of dissimilar connections in industry.

Combining various metals is complicated by the fact that they often form intermetallic phases, which are usually characterized by high hardness and brittleness. There are hard and brittle  $Cu_nAl_m$  type compounds in the aluminum-copper phase balance system [6]. The most important phases occurring in the two-component Al-Cu system from the point of view of soldering and welding processes are hard intermetallic phases (phases in the range of 58-78%at. Cu) that can arise during making connections [6,7]:

- $\theta - Al_2Cu$  (31,9÷33%at. Cu);
- $\gamma_1 - Al_4Cu_9$  (62,5÷69%at. Cu);
- $\delta - Al_2Cu_3$  (59,3÷61,9%at. Cu).

The presence of intermetallic phases in the joint structure reduces the strength properties of the joints and may lead to cracks in their operation. That is why the participation of intermetallic phases and their form in the connection is so important. Better properties are obtained when these phases are not large and occur in a dispersed form, and not in the form of clusters or a continuous coating at the grain boundaries. One of the ways to reduce the occurrence of intermetallic phases on the border between aluminum and other metals is to use appropriate diffusion barriers [8,9].  $Al_2O_3$

An additional difficulty of joining is the very high affinity of aluminum for oxygen, and the  $Al_2O_3$  oxide formed on its surface occurs in the form of a tight and durable layer [10].

The basic problems associated with joining aluminum with copper are:

- choosing the appropriate flux or gaseous environment that ensures the removal of oxides from the surface of such a variety of materials,
- creating brittle connections through the formation of intermetallic phases in the soldered joint, taking into account additional alloying elements found in the solder,
- a large difference in the chemical and physical properties of aluminum and copper.

The purpose of the work was to compare the properties of aluminum-copper pipe joints made by welding and soldering (using variable soldering binders), which find their application in industry as joints ensuring proper tightness.

Soldering is more used to make Al-Cu joints during assembly and to make such joints outside the production line or in small-lot production, while welding is used in mass production.

Identification of the occurring phases requires an analysis using the X-ray diffraction method, which is expensive under production conditions and was not the subject of the work, while hardness measurements can be a preliminary verification of the form of intermetallic phases.

## Soldering of Al-Cu joints

Flame soldering (propane oxygen) and resistance butt welding were used to make Al-Cu joints. Soldering was performed using zinc and aluminum binders, whose chemical composition is shown in table I.

The paper presents the results of tests on Al-Cu connections made of pipes with a diameter of  $\varnothing 6.9 \times 0.8$  mm made of Al-1070A aluminum and Cu-DHP copper.

The following additional materials for soldering were used in the tests:

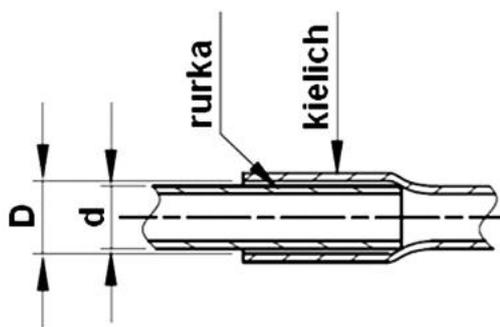
- CASTOLIN 192 FX flux;
- CASTOLIN Thinner 190AL flux fluid;
- binder – L-ZnAl2 in the form of a solid wire  $\varnothing 1,6$  mm (trade name CASTOLIN EcoBraz 38502T);
- binder –L-AlSi12  $\varnothing 1.6$  mm cored wire, designation according to PN-EN ISO 17672 [5].

The used additional materials are used both for soldering similar joints with aluminum and soldering dissimilar joints with aluminum and copper. The chemical composition and melting point of the binders used are shown in table I.

**Table I.** Chemical composition and melting point of binders

Binder	Wt.% content			Melting temperature °C
	Zn	Al	Si	
L-AlSi12	–	rest	12	575÷585
EcoBraz 38502T (L-ZnAl2)	rest	1.5÷4.5	–	377÷410

The studies used socket joints with a socket length of 12 mm. The design of the soldered joint is shown in figure 1. The size of the gap in the soldered joint at soldering temperature was about 0.084 mm in the joint with the socket in the aluminum tube, and about 0.065 mm in the joint with the socket in the copper tube, therefore both gaps should have high capillary properties. The types of soldered joints samples and additional materials used are presented in table II.

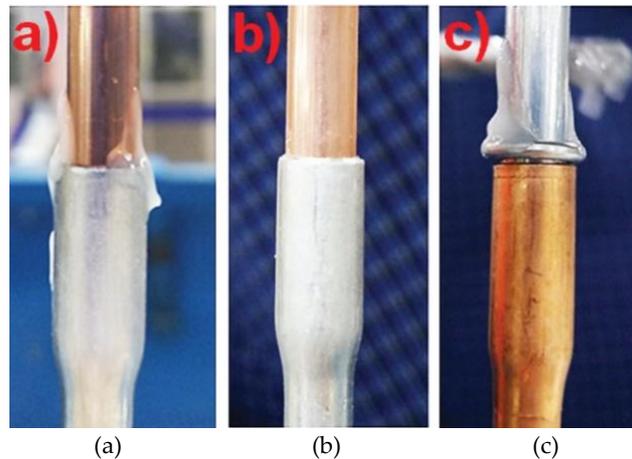


**Fig. 1.** Design of the socket joint of Al-Cu pipes

**Table II.** Types of soldered joints used in tests

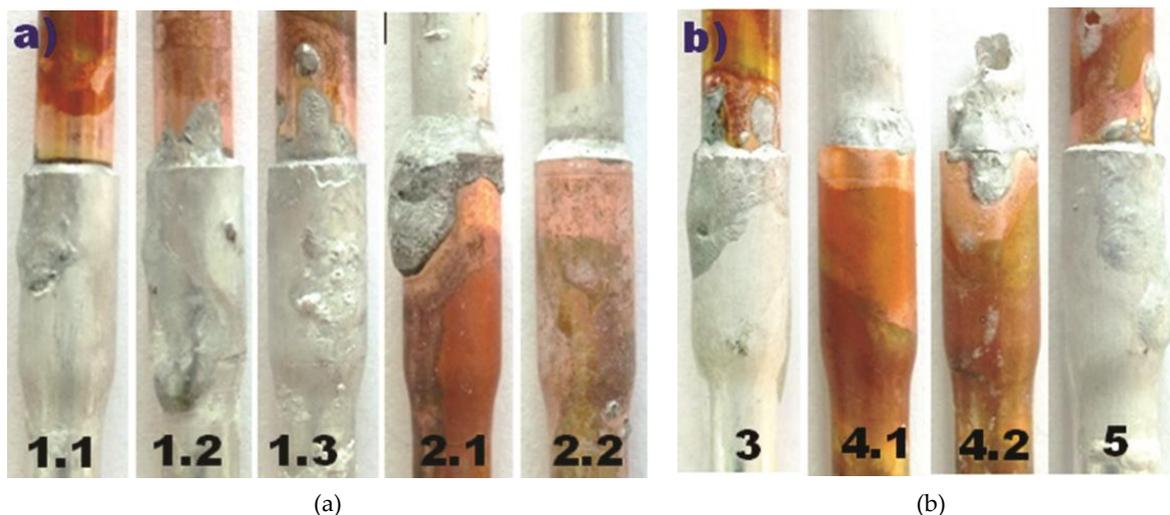
Series	1			2		3	4		5
Joint No.	1.1	1.2	1.3	2.1	2.2	3	4.1	4.2	5
Flux	192FX	192FX	192FX	192FX	192FX	In the wire	In the wire	In the wire	In the wire
Binder	ZnAl2	ZnAl2	ZnAl2	ZnAl2	ZnAl2	AlSi12	AlSi12	AlSi12	AlSi12
Solder form	Wire	Wire	Wire	Ring	Ring	Wire	Wire	Wire	Wire
Pipe	Cu	Cu	Cu	Al	Al	Cu	Al	Al	Cu
Socket	Al	Al	Al	Cu	Cu	Al	Cu	Cu	Al

The basic type of joint was made with a socket in an aluminum tube. To compare soldering properties, soldering tests were also carried out on joints with a copper pipe socket. View of the joints of pipes prepared for soldering is shown in figure 2.



**Fig. 2.** View of the joints of samples for soldering using different forms of binder: a) flux and binder in wire separately, b) core wire with flux in the center, c) flux and ring binder separately

During soldering, the flame was directed mainly at the copper tube. After soldering, all joints had excess solder on the outer surface of the socket. View of joints after soldering and cleaning the surface of flux residue is shown in figure 3.



**Fig. 3.** View of joints after soldering and cleaning of excess flux. Joint numbers according to designations of the samples given in Table 2; a) ZnAl<sub>2</sub> solder joints, b) AlSi<sub>12</sub> solder joints

As can be seen in figure 3, a large amount of binder remained on the socket, which did not flow into the capillary gap between the Al and Cu pipes. The damage to the aluminum tube visible in connector 4.2 was the result of excessive heating. The slight difference in melting temperatures of L-AlSi<sub>12</sub> solder (575-585 °C) and aluminum (660 °C) requires very precise heat input to the joint, which can be difficult even for an experienced solder.

Macrostructural tests of soldered joints (Fig. 4) with AlZn<sub>2</sub> solder showed good filling over the entire length of the overlap, while differences in the quality of filling the gap around the perimeter of the tube are visible in joints soldered with AlSi<sub>12</sub>. Connections 4.1, 4.2 and 5 made of AlSi<sub>12</sub> solder show that the required minimum fill length of 4 mm [11] for tight joints is also possible with aluminum solder.

### Welding of Al-Cu joints

For resistance welded joints, samples were prepared in accordance with figure 5. In this case, only the outer tube system made of aluminum was used, the inner tube was copper. The tubes used for welding were in the same delivery condition as the tubes used for soldering.

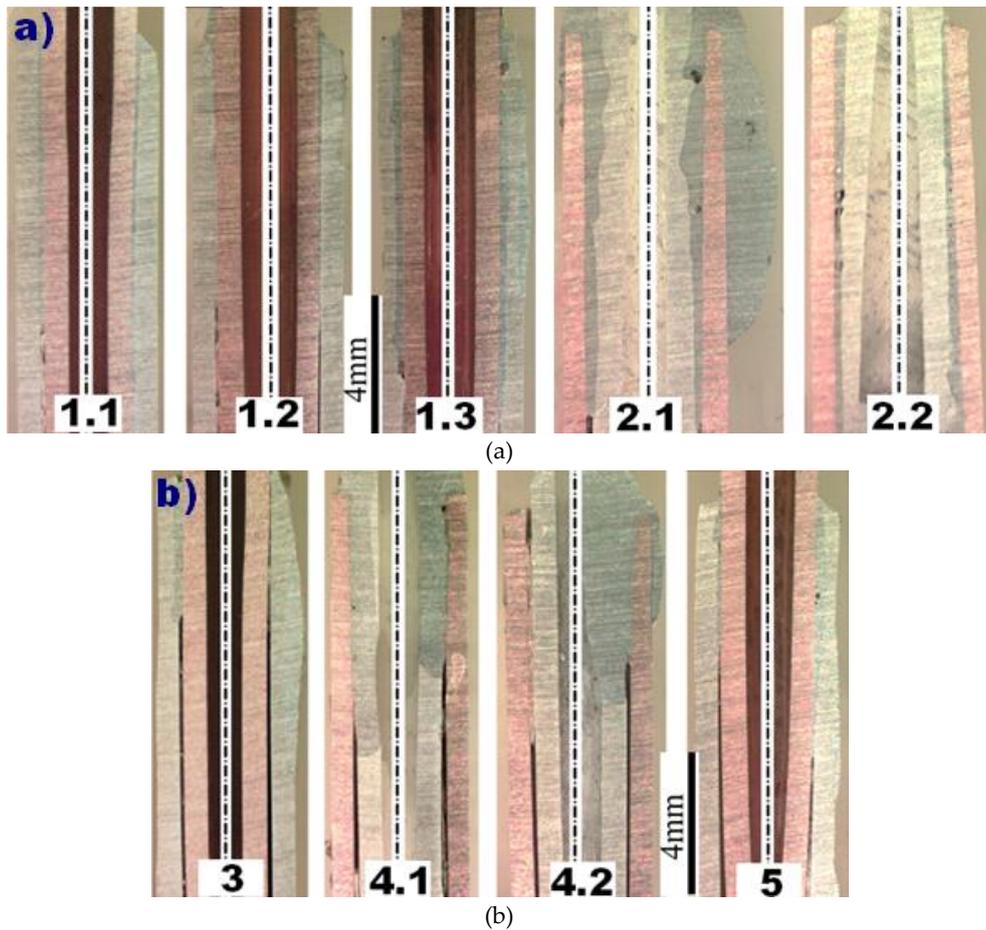


Fig. 4. Macrostructure of soldered Cu-Al joints: a) joints No. 1.1÷2.2 soldered with zinc solder; b) joints No. 3÷5 soldered with aluminum solder

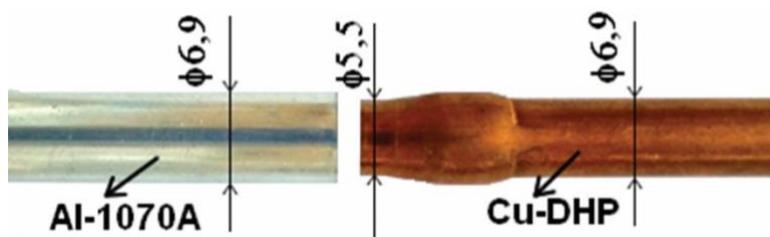


Fig. 5. Preparation of pipes for short-circuit resistance welding

During welding, the aluminum tube on the inner surface undergoes partial melting, and during upsetting in the final pressure of the welding process, the liquid metal is pushed out of the joint. View of Al-Cu resistance welded joints is shown in figure 6, and the macrostructure in figure 7.

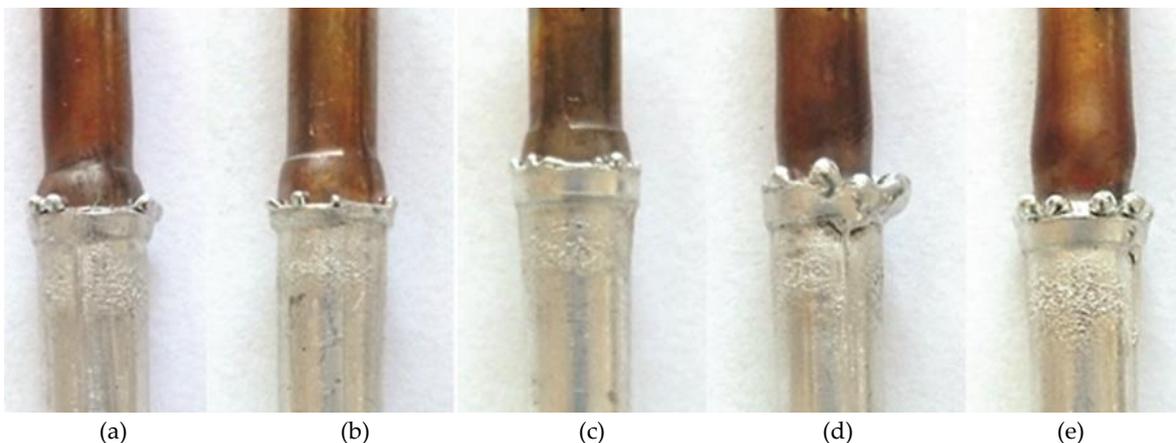


Fig. 6. View of Al-Cu resistance welded joints

The criteria for the correctness of making the joint are ensuring the tightness of the connection and the formation of a weld over a length of at least 2÷3 mm (in industrial conditions). As can be seen in figure 7, all joints meet this condition, the connection (solder) length is min. 4 mm.

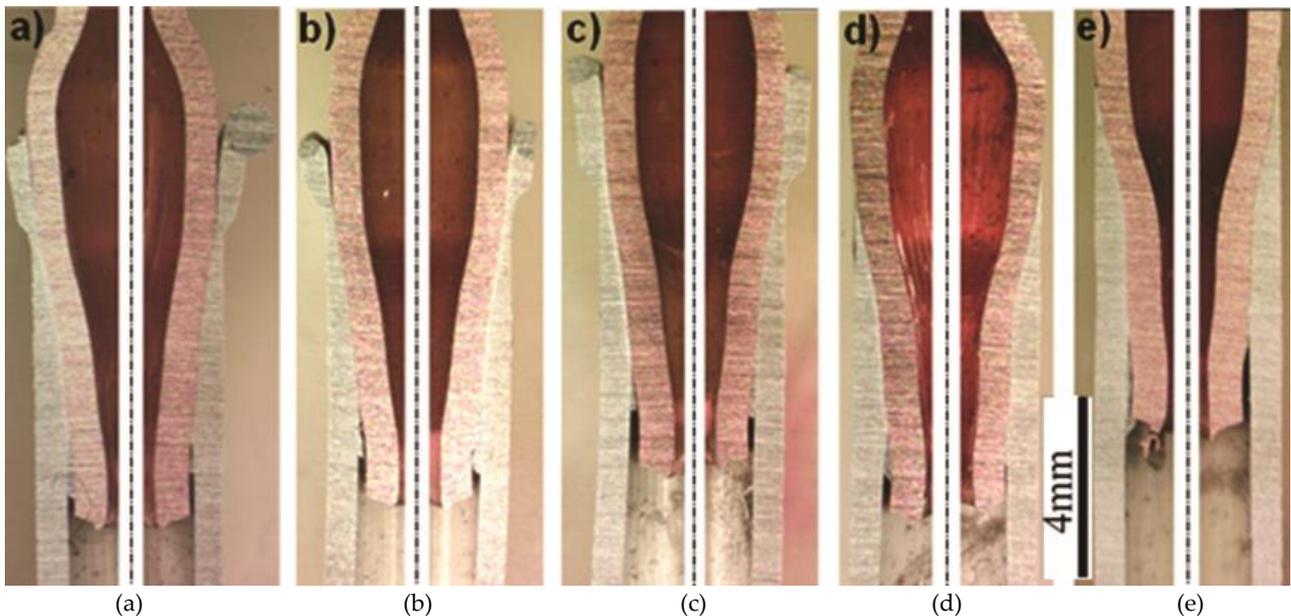


Fig. 7. Macrostructure of Al-Cu resistance welded joints

### Microscopic examinations

Comparing the structure of soldered and welded joints, it can be seen that in soldered joints there are areas marked as: Al, Al-L, L, L-Cu, Cu (Fig. 8a), while in welded joints there are areas of Al, Al-Cu, Cu (Fig. 8b). In soldered joints there is a large number of gas bubbles and clear erosion (dissolution of the native material) from the side of the aluminum tube (Figs. 8 and 9). In the welded joints on the welding line a narrow partial melting zone is visible.

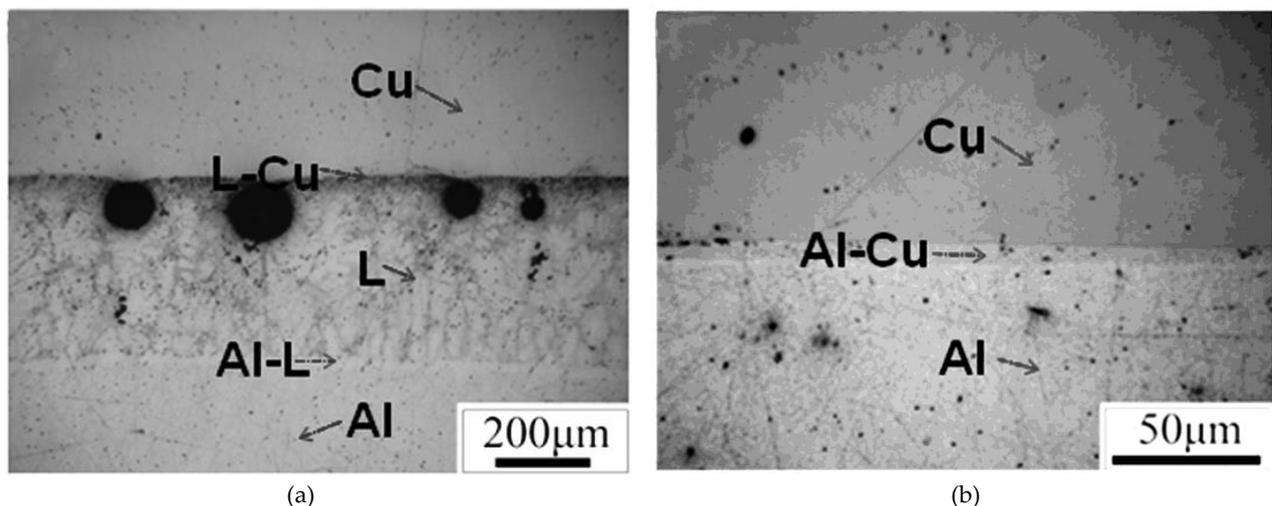


Fig. 8. Macrostructure of AL-Cu soldered and resistance welded joints: a) solder joint, Al-aluminum material, Al-L solder and aluminum diffusion zone, L-zinc solder, L-Cu-solder and copper diffusion zone, Cu-copper material; b) Al-aluminum material, AL-Cu - phases formed from aluminum and copper, Cu-copper material

### Hardness measurements

The hardness of soldered and welded joints was measured by the Vickers method at a load of 0.098N. The distribution of hardness measuring points in soldered and welded joints is shown in figure 9, while the measurement results are shown in figures 10 and 11.

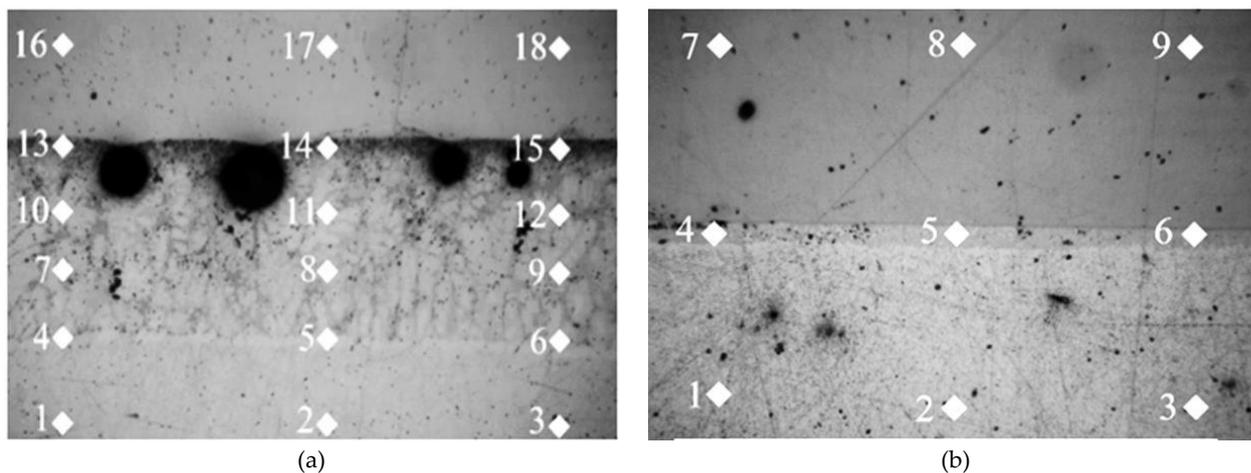


Fig. 9. Arrangement of hardness measurement points in: a) solder joints, b) resistance welded joints

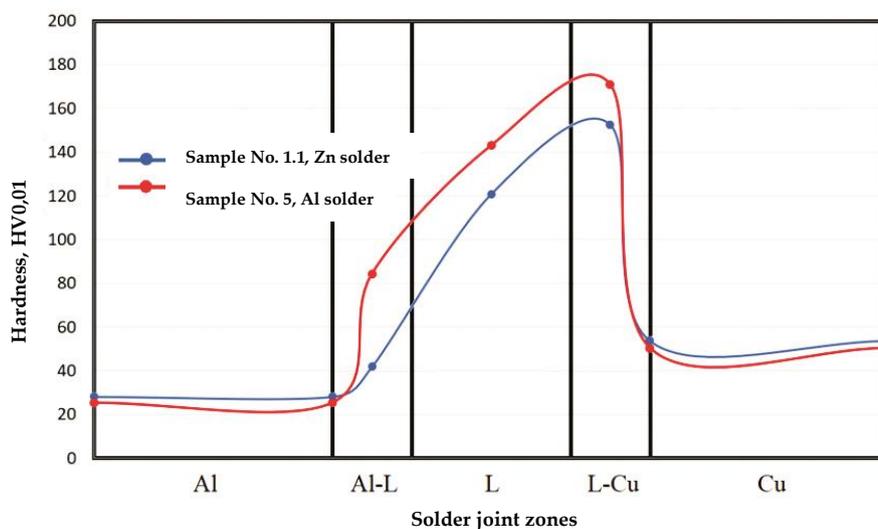


Fig. 10. Distribution of HV<sub>0,1</sub> hardness in Cu-Al soldered joints

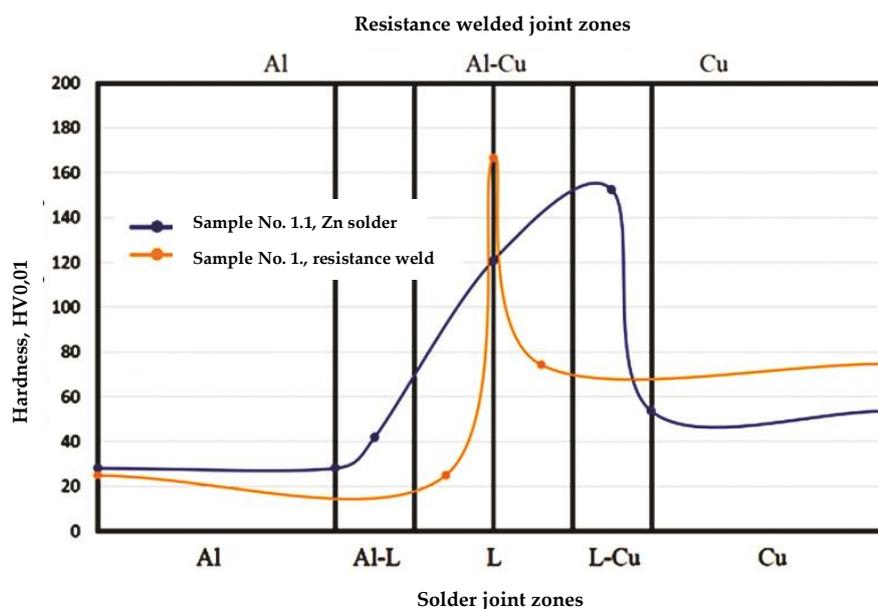


Fig. 11. Distribution of HV<sub>0,1</sub> hardness in Cu-Al soldered and resistance welded joints

Hardness measurements were aimed at determining whether in the connection area both in the soldering process and in the welding process there are no hard and brittle intermetallic phases that can be observed in the Al-Cu equilibrium system causing a significant reduction in the operational properties of the connections [12]. During the operation of the compressor aggregate, due to the occurring vibrations,

micro-cracks may appear between the matrix and non-coherent precipitations of the Al<sub>2</sub>Cu metallic phase, which during long-term operation lead to cracks.

Hardness measurements show that in both soldered and welded joints there is an increase in hardness compared to the hardness of native copper and aluminum materials. In the soldered joint this increase occurs in the copper diffusion area, while in the welded joint on the aluminum and copper melting line. As demonstrated in [13,14], the reason for the increase in hardness are the intermetallic phases of aluminum and copper formed in soldered and welded joints, and as you can presume the consequence of their presence is usually a reduction in mechanical properties [15].

## Conclusions

1. The use of ZnAl<sub>2</sub> zinc binder for soldering the Al-Cu pipe connection allows to obtain a solder connection with better parameters (length of formed solder) and quality (fewer pores in the solder and bubbles than in joints made with AlSi<sub>12</sub> solder).
2. The main problems occurring when making soldered joints are: limited wetting of copper surface by liquid solder, formation of hard and brittle intermetallic phases and ease of overheating (partial melting) of the aluminum tube.
3. The main disadvantage of welded joints is the presence of hard and brittle intermetallic phases in the Al-Cu transition zone, which cause a step change in hardness in the joint. The consequence of these phases is usually a reduction in the mechanical properties. Avoiding the formation of these phases is difficult because the said structure is formed during the welding process and its production is necessary for the proper formation of the weld and cleaning of the adjacent copper and aluminum surfaces, therefore solder joints are more favorable from the point of view of operational properties.
4. The quality of solder joints made by flame soldering is strongly related to the skills of the solder. Obtaining perfect repeatability of the connection process is not possible. The method has limited application in mass production because it is difficult to automate and increase the speed of making connections.
5. The use of soldering is recommended for making Al-Cu joints during assembly and making such connections off the production line due to the ease of application of this method regardless of the conditions, position of soldering and complexity of the connection.
6. Welded joints made in a semi-automatic process are characterized by greater repeatability of the process and the quality of the joints obtained. The nature of the process also allows its full automation and application in mass production.

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